ABSTRACT OF THE DISCLOSURE

An organopolysiloxane composition is provided including: (A) an organopolysiloxane with hydroxyl groups at both terminals of the molecular chain; (B) an organosilicon compound represented by the general formula shown below:

wherein, R² represents a hydrogen atom, a phenyl group or a halogenated phenyl group, R³ represents a hydrogen atom or a methyl group, R⁴ represents a monovalent 10 hydrocarbon group, X represents a hydrolysable group, Z¹ represents -R⁵-, -R⁵O- or -R⁵(CH₃)₂SiO- (wherein R⁵ represents a bivalent hydrocarbon group), Z² represents an oxygen atom or a bivalent hydrocarbon group, m represents 0, 1 or 2, and n represents 0, 1 or 2; (C) a condensation curing catalyst; and (D) a photopolymerization initiator. This composition has two curing mechanisms, namely photopolymerizability and condensation curability, and displays superior adhesiveness, and in particular displays favorable adhesiveness to a substrate immediately following irradiation with ultraviolet light.

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